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DATA SHEETS (1) DATA SPECS SIM MODELS & SOFTWARE	ROHSDOCUMENTATIONPARTS WITH THE SAMECERTIFICATES& SUPPORTDATA SHEET (4)	WHERE TO BUY
	Data Sheets (1)	
Data Sheet		
L73A NAND datasheet		China MLC NAND

L73A NAND datasheet

 File Type: PDF
 Updated: 08/2015

Specs

NAND Flash

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SEE ALL MLC NAND PARTS

Taiwan USA

Orderable Parts for: MT29F32G08CBACAWP-Z

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MT29F32G08CBACAWP- Z:C	Contact Factory	N/A	N/A	N/A	N/A	No		VIEW

Detailed Specifications

Density	32Gb	Status	Contact Factory	NAND Type	2D	RoHS	Yes
Width	x8	Voltage	3.3V	Package	TSOP	Pin Count	48-pin
Op. Temp.	0C to +70C	MT/s		I/O	Common	Product Name	

Sim Models & Software

Sim Models

HSpice	
HSpice: NAND 32/64/128/256Gb MLC (Rev C) L73A (ZIP)	MLC NAND NAND Flash
REV 2.1	
File Type: ZIP Updated: 01/13/2012	DOWNLOAD
IBIS 🔒	
IBIS: NAND 32/64/128/256Gb MLC (Rev C) L73A (ZIP)	MLC NAND NAND Flash
Rev. 2.1	
File Type: ZIP Updated: 01/13/2012	DOWNLOAD
Software	
Software Support Pack	
mtd-nand-use-a-lower-value-for-badblockbits-when-working-with-MLC-NAND (ZIP)	MLC NAND NAND Flash
MLC NANDs have more bit flips that SLC. When looking for bad block marker we have a lot of false positive if we check for the whole byte. To avoid this tolerate a few (4 here) bit flips for byte.	
File Type: ZIP Updated: 03/31/2016	DOWNLOAD
Software Support Pack	
NAND FLASH lockunlock bug fix (ZIP)	MLC NAND NAND Flash
Reset NAND before write protect check.	SLC NAND
File Type: ZIP Updated: 03/31/2016	DOWNLOAD
Software Support Pack	
fixup-ubi-cannot-recover-master node issue (ZIP)	MLC NAND NAND Flash
For MLC NAND, paired page issue is now a common known issue. This patch is just for master node cannot be recovered while there will two pages be dameged in one single master block.	
File Type: ZIP Updated: 03/31/2016	DOWNLOAD
Software Support Pack	

These patches aim to solve MLC NAND paired page power loss issue by adding a bakvol (backup volume) module in UBI layer. 70 series and 80 series families.

File Type: ZIP
Updated: 03/31/2016

Convert Pack

YAFFS mark bad block issue (ZIP)
If the bitflips num over mtd->bitflip_threshold the mtd_read_oob will return -EUCLEAN and tags->ecc_result > YAFFS_ECC_RESULT_NO_ERROR. Then we will call yaffs_handle_chunk_error.
File Type: ZIP
Updated: 03/31/2016
DOWNLOAD

RoHS Certificates

RoHS Certificates		
RoHS Certificate	of Compliance (PDF)	MT29F32G08CBACAWP-Z
	ation of how this product meets the requirements of the current DIRECTIVE restriction of Hazardous Substances (RoHS) Directive.	
File Type: (PDF)	Updated: 11/2016	DOWNLOAD
RoHS Certificates		
China RoHS Certi	ficate (PDF)	MT29F32G08CBACAWP-Z
Part-specific certific Electronic Informat	ation as required by China's Management Methods for Controlling Pollution by ion Products.	
File Type: (PDF)	Updated: 11/2016	DOWNLOAD

Documentation & Support

See All MLC NAND Documentation

Technical Notes

SEARCH (4) MLC NAND TECHNICAL NOTES

Technical Notes

TN-00-33: Power Integrity Simulation with IBIS 5.0 Models (PDF) Downloaded from Arrow.com.

		DDR4 SDRAM
(TN-00-33) This	technical note describes the new features in IBIS 5.0 enabling PI simulation. It also	DRAM
provides an ove	rview of some of the modeling accuracy challenges and compares SSO simulation	See More Tags
results using va	rious electronic design automation (EDA) software tools.	
File Type: PDF	Updated: 01/25/2016	DOWNLOAD
Technical Notes		
TN-00-01: Moi	sture Sensitivity of Plastic Packages (PDF)	DDR SDRAM
		DDR2 SDRAM DDR3 SDRAM
		DDR3L-RS
	technical note describes shipping procedures for preventing memory devices from	See More Tags
absorbing moist	ture and recommendations for baking devices exposed to excessive moisture.	
File Type: PDF	Updated: 02/14/2013	DOWNLOAD
Technical Notes		
TN-29-65: Soft	ware Device Drivers for Very Large Page Micron NAND Flash Memory	MLC NAND
(PDF)		NAND Flash SLC NAND
(TN-29-65) Dowi	nload the low-level driver described in this document here.	
File Type: PDF	Updated: 10/15/2010	DOWNLOAD
Technical Notes		
TN-29-61' Wea	ar Leveling in NAND Flash Memory (PDF)	MLC NAND
		NAND Flash SLC NAND
		52010400
(TN-29-61) This 1	technical note describes the recommended wear leveling algorithm to be	
	technical note describes the recommended wear leveling algorithm to be the FTL software for NAND Flash memory.	
		DOWNLOAD

SEARCH (4) MLC NAND TECHNICAL NOTES

Parts with the same Data Sheet (4)

	MT29F32G08CBACAWP-Z MT2 (Current)		MT29F32G08CBACAWP-ITZ	F32G08CBACAWP-ITZ MT29F32G08CBCCBH1-12Z	
	Status	Contact Factory	Contact Factory	Contact Factory	Production
	Density	32Gb	32Gb	32Gb	32Gb
Dow	NAND Type	2D Arrow.com.	2D	2D	

	RoHS	Yes	Yes	Yes	Yes	
	Width	x8	x8	x8	x8	
<	Voltage	3.3V 3.3V		3.3V	3.3V	
	Package	TSOP	TSOP	VBGA	VBGA	
	Pin Count 48-pin		48-pin	100-ball	100-ball	
	Op. Temp. OC to +70C		-40C to +85C	0C to +70C	-40C to +85C	
		MT/s		166 MT/s	166 MT/s	
	I/O	Common	Common	Common	Common	
	F	Product Name				

Where to Buy

Orderable Parts

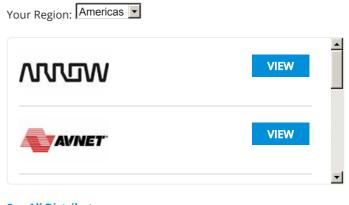
<

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MT29F32G08CBACAWP- Z:C	Contact Factory	N/A	N/A	N/A	N/A	No		VIEW

Contact Your Sales Rep

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- OR - Check with Distributors



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Client SSD Storage	DRAM	News and Events	Authorized Distributors	Authorized Sales
Data Center Embedded Memory Solutions Enterprise SSD Storage	DRAM Modules NAND Flash Managed NAND	Micron Blogs Micron Foundation Emerging Technologies	Contact Us Jobs	Site Map Surplus Equipment
Mobile Memory Solutions Networking Innovations Supercomputing Memory Ultrathin Solutions	NOR Flash Hybrid Memory Cube Multichip Packages Solid State Drives	Locations Our Commitment Investor Relations		Terms of Use Terms and Conditions of Sale Privacy

crucial

EXPLOSIT X



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